 OMB No. 0651-0011(12/31/86

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Submitted by:	Atty. Docket No.	Serial No.
	DP-307055	
	Applicant	
SCOTT A. MCBAIN Delphi Technologies, Inc.,	BRIAN K FULLER, et al	
	Filing Date	Group
Reg. No. 37181	Herewith	

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Examiner | Date Considered

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F rm PTO-FB-A820 (also PTO-1449) Patent & Trademark Office-US Dept. of Commerce

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Signature: Deborah A Evans

Name: Deborah A. Evans

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	DP-306805	
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Reg. No. 37181	Herewith	

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	Applicant	
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	Filing Date	Group
Reg. No. 37181	Herewith	

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SCOTT A. MCBAIN Delphi Technologies, Inc., Reg. No. 37181	Applicant BRIAN K FULLER et al Filing Date Herewith	Group

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SCOTT A. MCBAIN Delphi Technologies, Inc., Reg. No. 37181	Applicant JOHN R. SMITH	
	Filing Date	Group

U.S. PATENT DOCUMENTS

Exam. Init.	Document Number	Date	Name	Class	Sub Class	Filing Date (if approp.)
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✓	6,129,948	10-10-2000	Plummet et al			
✓	6,139,913	10-31-2000	Van Steenkiste et al			
	6,283,386	09-04-2001	Van Steenkiste et al			

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